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MJB5742T4G

NPN Silicon Power Darlington Transistors

The Darlington transistors are designed for high-voltage power switching in inductive circuits.

Features

- These Devices are Pb-Free and are RoHS Compliant

Applications

- Small Engine Ignition
- Switching Regulators
- Inverters
- Solenoid and Relay Drivers
- Motor Controls

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO(sus)}$	400	Vdc
Collector-Emitter Voltage	V_{CEV}	800	Vdc
Emitter-Base Voltage	V_{EB}	8	Vdc
Collector Current – Continuous – Peak (Note 1)	I_C I_{CM}	8 16	Adc
Base Current – Continuous – Peak (Note 1)	I_B I_{BM}	2.5 5	Adc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	2 0.016	W W/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	100 0.8	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.25	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C}/\text{W}$
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 5 Seconds	T_L	275	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

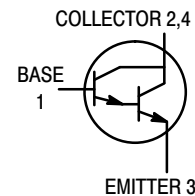
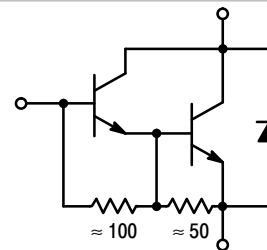
1. Pulse Test: Pulse Width = 5 ms, Duty Cycle $\leq 10\%$.



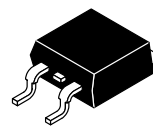
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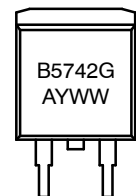
POWER DARLINGTON TRANSISTORS 8 AMPERES, 400 VOLTS 100 WATTS



MARKING DIAGRAM



**D²PAK
CASE 418B
STYLE 1**



B5742 = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping†
MJB5742T4G	D ² PAK (Pb-Free)	800 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS (Note 2)

Collector–Emitter Sustaining Voltage (I _C = 50 mA, I _B = 0)	V _{CEO(sus)}	400	–	–	Vdc
Collector Cutoff Current (V _{CEV} = Rated Value, V _{BE(off)} = 1.5 Vdc) (V _{CEV} = Rated Value, V _{BE(off)} = 1.5 Vdc, T _C = 100°C)	I _{CEV}	–	–	1 5	mAdc
Emitter Cutoff Current (V _{EB} = 8 Vdc, I _C = 0)	I _{EBO}	–	–	75	mAdc

SECOND BREAKDOWN

Second Breakdown Collector Current with Base Forward Biased	I _{S/b}	See Figure 6			
Clamped Inductive SOA with Base Reverse Biased	RBSOA	See Figure 7			

ON CHARACTERISTICS (Note 2)

DC Current Gain (I _C = 0.5 Adc, V _{CE} = 5 Vdc) (I _C = 4 Adc, V _{CE} = 5 Vdc)	h _{FE}	50 200	100 400	– –	–
Collector–Emitter Saturation Voltage (I _C = 4 Adc, I _B = 0.2 Adc) (I _C = 8 Adc, I _B = 0.4 Adc) (I _C = 4 Adc, I _B = 0.2 Adc, T _C = 100°C)	V _{CE(sat)}	– – –	– – –	2 3 2.2	Vdc
Base–Emitter Saturation Voltage (I _C = 4 Adc, I _B = 0.2 Adc) (I _C = 8 Adc, I _B = 0.4 Adc) (I _C = 4 Adc, I _B = 0.2 Adc, T _C = 100°C)	V _{BE(sat)}	– – –	– – –	2.5 3.5 2.4	Vdc
Diode Forward Voltage (Note 3) (I _F = 5 Adc)	V _f	–	–	2.5	Vdc

SWITCHING CHARACTERISTICS

Typical Resistive Load (Table 1)					
Delay Time	(V _{CC} = 250 Vdc, I _{C(pk)} = 6 A I _{B1} = I _{B2} = 0.25 A, t _p = 25 μs, Duty Cycle ≤ 1%)	t _d	–	0.04	– μs
Rise Time		t _r	–	0.5	– μs
Storage Time		t _s	–	8	– μs
Fall Time		t _f	–	2	– μs
Inductive Load, Clamped (Table 1)					
Voltage Storage Time	(I _{C(pk)} = 6 A, V _{CE(pk)} = 250 Vdc I _{B1} = 0.06 A, V _{BE(off)} = 5 Vdc)	t _{sv}	–	4	– μs
Crossover Time		t _c	–	2	– μs

2. Pulse Test: Pulse Width 300 μs, Duty Cycle = 2%.

3. The internal Collector–to–Emitter diode can eliminate the need for an external diode to clamp inductive loads. Tests have shown that the Forward Recovery Voltage (V_f) of this diode is comparable to that of typical fast recovery rectifiers.

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TYPICAL CHARACTERISTICS

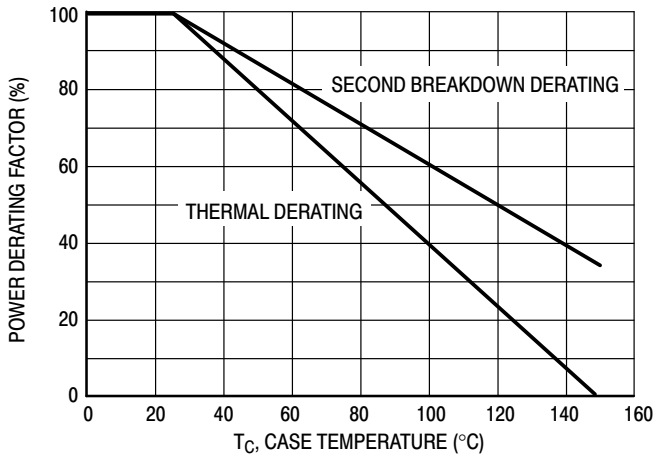


Figure 1. Power Derating

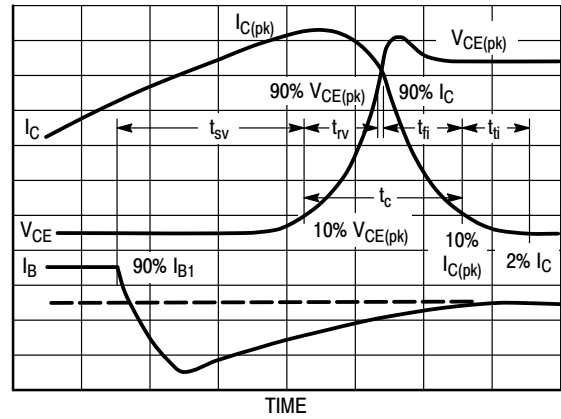


Figure 2. Inductive Switching Measurements

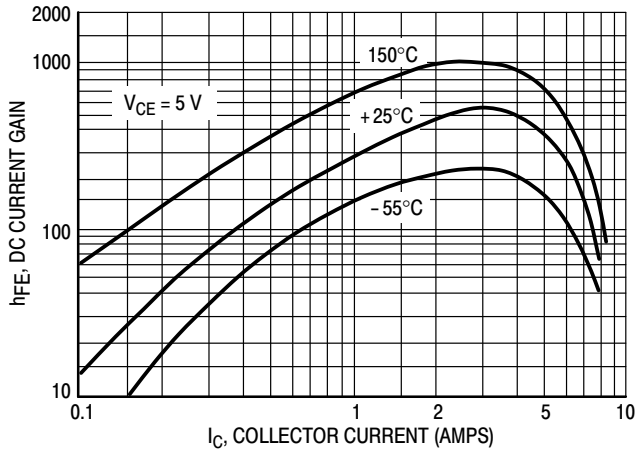


Figure 3. DC Current Gain

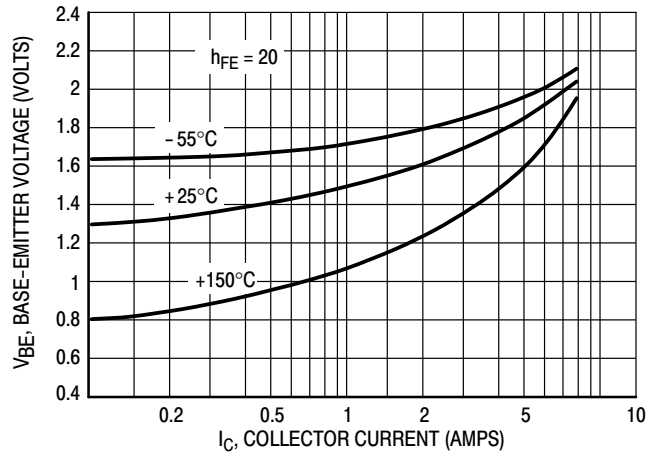


Figure 4. Base-Emitter Voltage

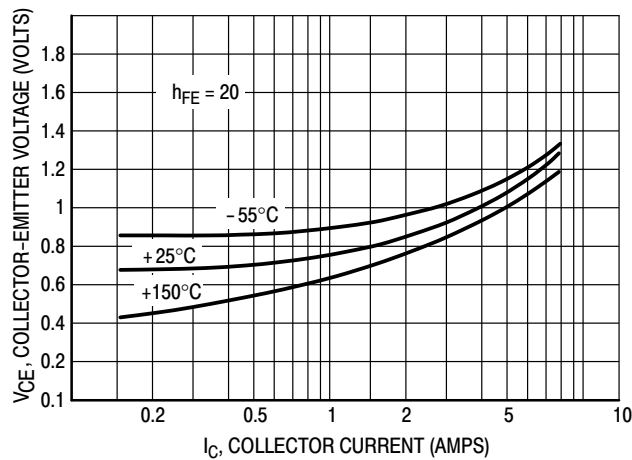


Figure 5. Collector-Emitter Saturation Voltage

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Table 1. Test Conditions for Dynamic Performance

REVERSE BIAS SAFE OPERATING AREA AND INDUCTIVE SWITCHING		RESISTIVE SWITCHING
TEST CIRCUITS	<p>DUTY CYCLE $\leq 10\%$ $t_r, t_f \leq 10$ ns</p> <p>NOTE: PW and V_{CC} Adjusted for Desired I_C R_B Adjusted for Desired I_{B1}</p>	
CIRCUIT VALUES	<p>COIL DATA: FERROXCUBE CORE #6656 FULL BOBBIN (~16 TURNS) #16</p> <p>GAP FOR 200 μH/20 A $L_{coil} = 200$ μH</p> <p>$V_{CC} = 30$ V $V_{CE(pk)} = 250$ Vdc $I_{C(pk)} = 6$ A</p>	<p>$V_{CC} = 250$ V $D1 = 1N5820$ OR EQUIV.</p>
TEST WAVEFORMS	<p>OUTPUT WAVEFORMS</p> <p>t_1 ADJUSTED TO OBTAIN I_C</p> $t_1 \approx \frac{L_{coil} (I_{C(pk)})}{V_{CC}}$ <p>TEST EQUIPMENT SCOPE-TEKTRONICS 475 OR EQUIVALENT</p> $t_2 \approx \frac{L_{coil} (I_{C(pk)})}{V_{clamp}}$	<p>$t_r, t_f < 10$ ns DUTY CYCLE = 1% R_B AND R_C ADJUSTED FOR DESIRED I_B AND I_C</p>

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SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 6 is based on $T_C = 25^\circ\text{C}$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \geq 25^\circ\text{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 6 may be found at any case temperature by using the appropriate curve on Figure 1.

The Safe Operating Area figures shown in Figures 6 and 7 are specified ratings for these devices under the test conditions shown.

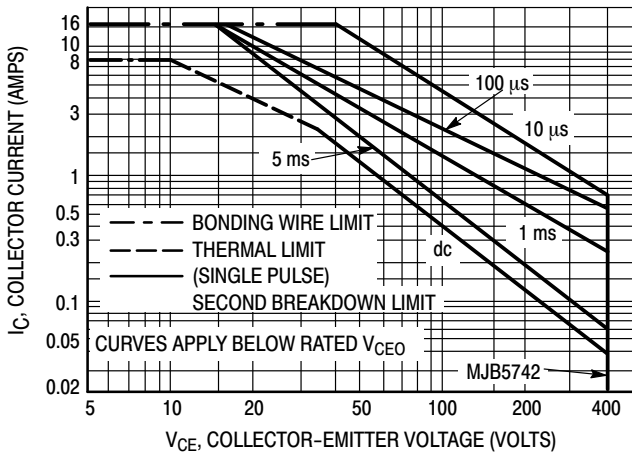


Figure 6. Forward Bias Safe Operating Area

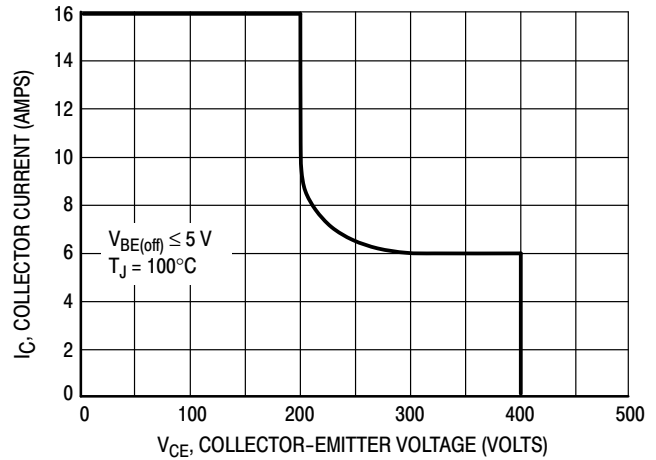


Figure 7. Reverse Bias Safe Operating Area

RESISTIVE SWITCHING PERFORMANCE

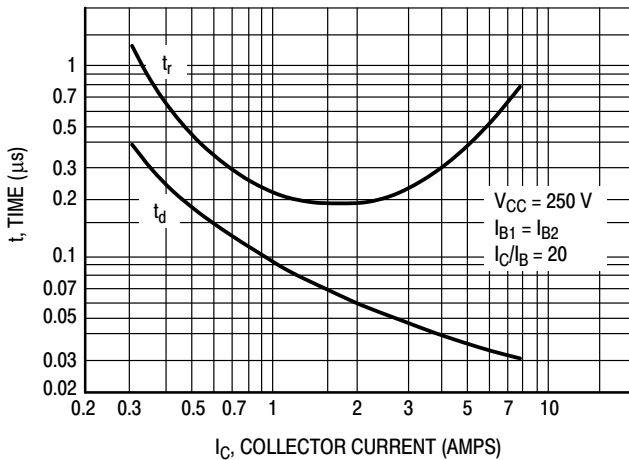


Figure 8. Turn-On Time

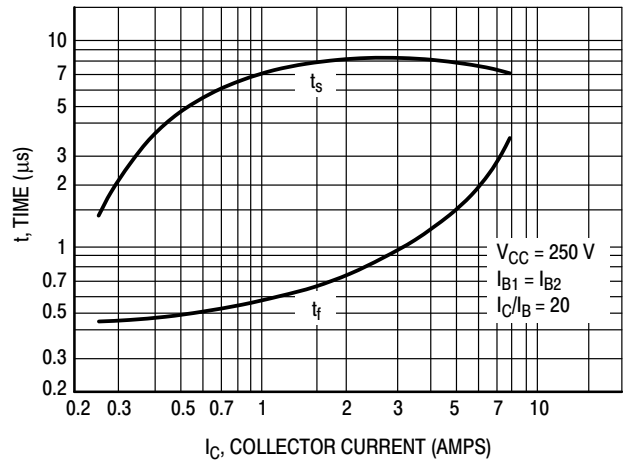
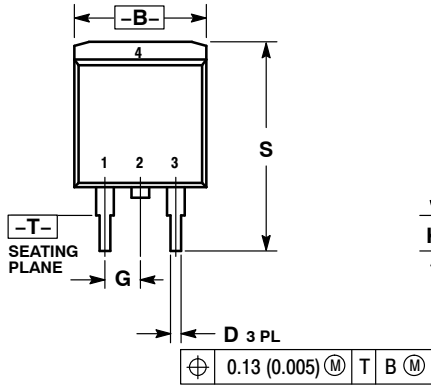


Figure 9. Turn-Off Time

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PACKAGE DIMENSIONS

D²PAK 3 CASE 418B-04 ISSUE K



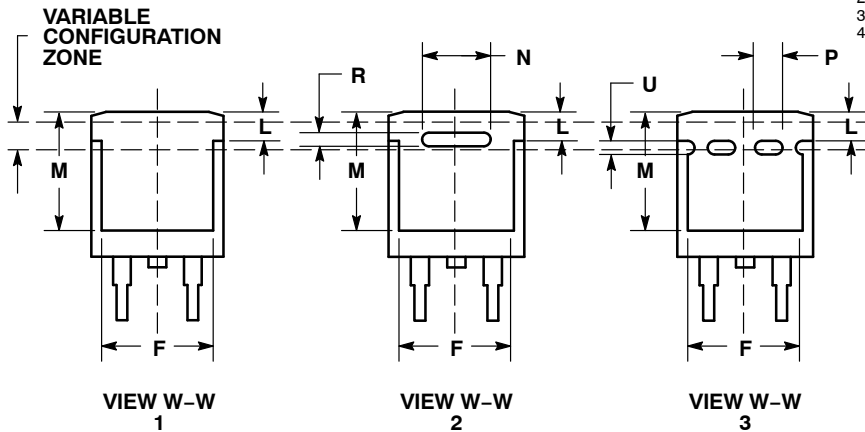
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

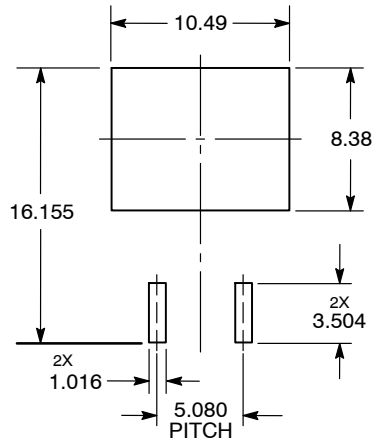
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.340	0.380	8.64	9.65
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100 BSC		2.54 BSC	
H	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
M	0.280	0.320	7.11	8.13
N	0.197 REF		5.00 REF	
P	0.079 REF		2.00 REF	
R	0.039 REF		0.99 REF	
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40

STYLE 1:

- PIN 1. BASE
- COLLECTOR
- EMITTER
- COLLECTOR




SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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